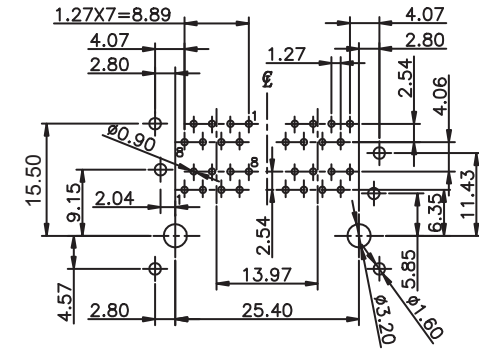
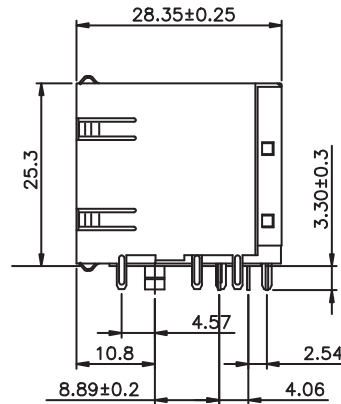
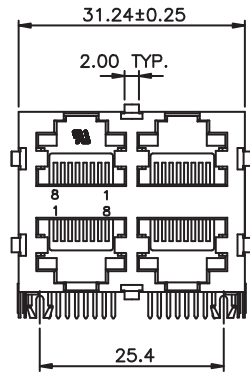




PC Board t=1.6mm
Component Side Shown

MATERIAL:

INSULATOR: PBT Glass Filled (UL94V-0)
CONTACT: 0.35mm Thickness Phosphor Bronze
CONTACT PLATING: Gold Plating Over Nickel

MECHANICAL:

DURABILITY: 500 Mating Cycles Min.

ELECTRICAL:

VOLTAGE RATING: 120 V AC RMS
CURRENT RATING: 1.5A Min.
CONTACT RESISTANCE: 20 milli-Ohm Max.
INSULATION RESISTANCE: 1,000 mega-Ohm Min.
DIELECTRIC STRENGTH: 1000 VAC RMS 60HZ, 1 Min.
OPERATING TEMPERATURE: -25° C to +90° C

HOW TO ORDER:

A 3 0 2 0 - 0 4 I - S T 3 - X 0 4 - Z

SELECTIVE PLATING:

6 - Au CONTACT AREA/TIN TAIL
7 - 15u" Au CONTACT AREA/TIN TAIL
8 - 30u" Au CONTACT AREA/TIN TAIL
9 - 50u" Au CONTACT AREA/TIN TAIL

**RoHS
COMPLIANT**

Rev	Drawn	Checked	Approved	Date	SMP TECHNOLOGY, INC.
0	MDH	S.M.	S.M.	09/09/04	
A	WHS	G.C.	S.M.	09/20/06	RJ45 Ganged Jack, 2x2, Side Entry with Panel Grounds on Top, Sides, & Bottom
SCALE: N/A					P/N: A3020-04I-ST3-X04-Z
TOL. DEC.	.X +/- 0.20	.XX +/- 0.15	.XXX +/- 0.075	ANGLE +/-	
UNIT: mm					Pg: 1